

2.4GHz 3216 Chip Antenna: RANT3216F245C03

Application:

WLAN, 802.11b/g, Bluetooth, WLAN,
etc.

Features

SMD, high reliability, ultra Impact, Omni-directional.

Part number

Information
 3216 F 245 C 03
 (A) (B) (C) (D) (E) (F)



(A) Product Type	Chip Antenna
(B) Size Code	3.2x1.6mm(±0.2mm)
(C) Material	High K material
(D) Frequency	2.4 ~ 2.5GHz
(E) Feeding mode	PIFA & Single Feeding
(F) Antenna type	Feeding

Type=03

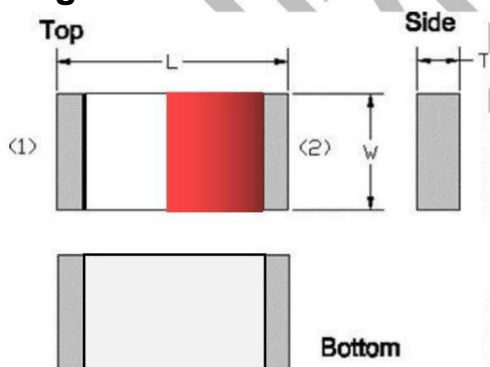
Electrical Specification

Working Frequency Range	2400 ~2500 MHz
Bandwidth	120 MHz (Min.)
Peak Gain	1.24 dBi (Typ.)
Impedance	50 Ohm
Return loss	10 dB
Polarization	(Min.) Linear
Azimuth Beamwidth	Omni-directional
Operation Temperature(°C)	-40 ~85°C
Resistance to Soldering	10sec. (@
Heats Termination	280°C)

The specification is defined on EVB.

Ni / Au
(Leadless)

Dimension and Terminal Configuration

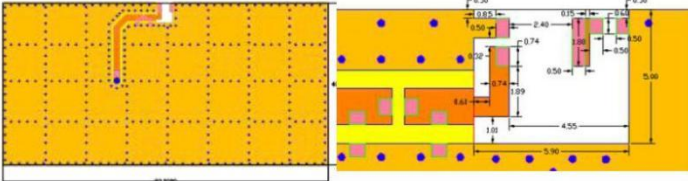
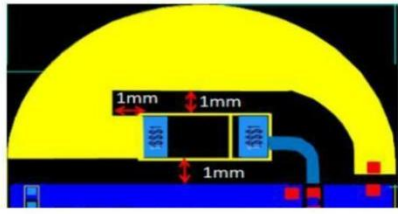


Dimension (mm)	
L	3.20 ± 0.20
W	1.60 ± 0.20
T	0.45 ± 0.20

No.	Terminal Name
1	Feeding/GNG
2	GND/Feeding

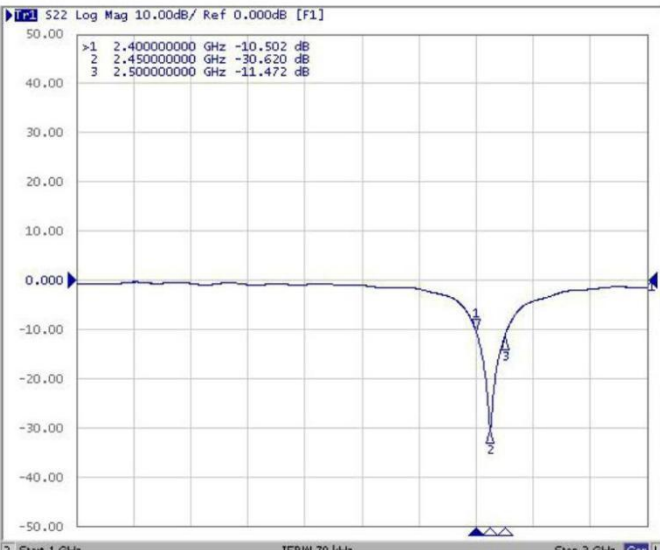
2.4GHz 3216 Chip Antenna: RANT3216F245C03 Evaluation Board



Reference 长条板PCB 推荐 Dimension	圆板Antenna Layout Reference
	 <p style="text-align: right;">Unit :mm</p>

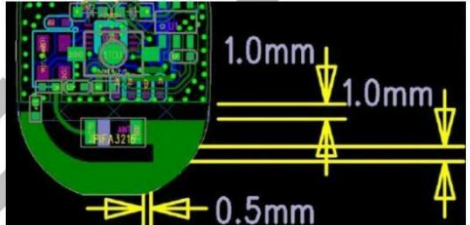
Electrical Characteristics

Return Loss



Frequency (GHz)	Return Loss (dB)
2.400000000	-10.502
2.450000000	-30.620
2.500000000	-11.472

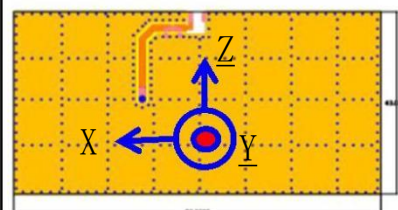
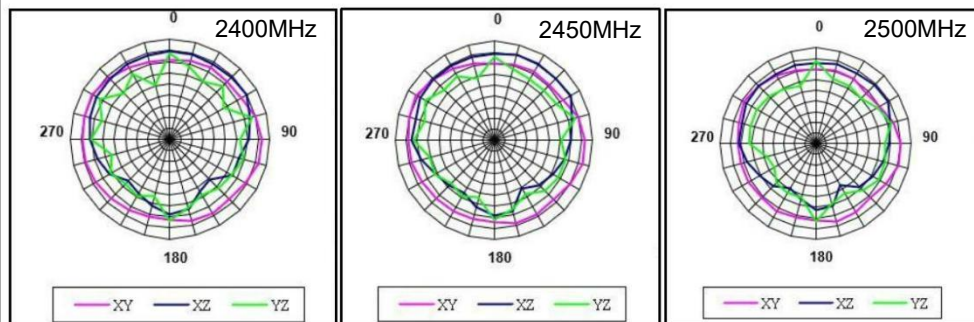
Return Loss & Radiation



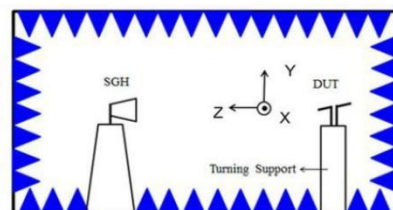
Frequency(MHz)	S11 (dB)
2400	-10.50
2450	-30.62
2500	-11.47

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Radiation



	2400MHz	2450MHz	2500MHz
Efficiency	82.52%	85.26%	83.01%
Peak Gain	1.15 dBi	1.24 dBi	1.19 dBi
Directivity	1.89 dBi	1.97 dBi	1.91 dBi

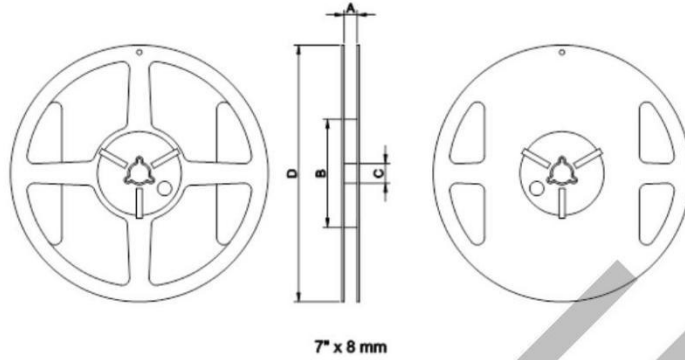


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2.4GHz 3216 Chip Antenna:
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Taping Specifications

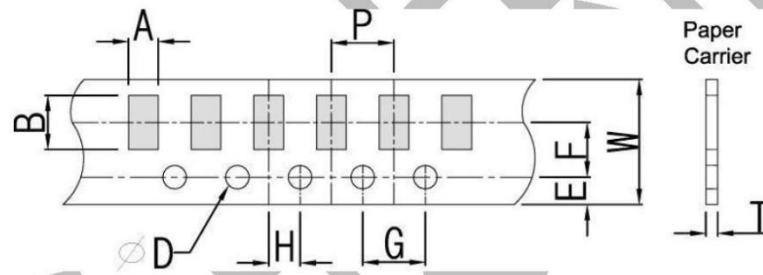
Reel and Taping Specification

Reel Specification



TYPE	SIZE		A	B	C	D
3216	7"	5K/Reel	9.0±0.5	60±2	13.5±0.5	178±2

Tapping Specification



Packaging	Type	A	B	W	E	F	G	H	T	ψ D	P
Paper Type	3216	1.90±0.2 4.0±0.1	3.50±0.2 0	8.0±0.2 0	1.75±0.1 0	3.5±0.05	4.0±0.10	2.0±0.05	0.75±0.1 0	0	1.50±0.1

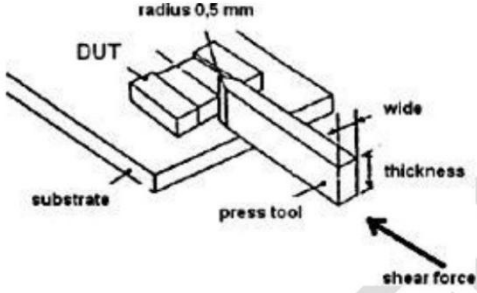
2.4GHz 3216 Chip Antenna: RANT3216F245C03 Reliability Table



Test Item	Procedure	Requirements Ceramic Type	Remark (Reference)
Electrical Characterization		Fulfill the electrical specification	User Spec.
Thermal Shock	<ol style="list-style-type: none"> Preconditioning: 50 ± 10°C / 1 hr , then keep for 24 ± 1 hrs at room temp. Initial measure: Spec: refer Initialspec. Rapid change of temperature test: -30 to +85°C; 10 cycles; 15 minutes at Lower category temperature; 15 minutes at Upper category temperature. 	No Visible Damage. Fulfill the electrical specification.	MIL-STD-202 107
Temperature Cycling	<ol style="list-style-type: none"> Initial measure: Spec: refer Initialspec. 100 Cycles (-30°C to +85°C), Soak Mode=1 (2 Cycle/hours). Measurement at 24 ± 2Hours after testcondition. 	No Visible Damage. Fulfill the electrical specification.	JESD22 JA104
High Temperature Exposure	<ol style="list-style-type: none"> Initial measure: Spec: refer Initialspec. Unpowered; 500hours @ T=+85°C. Measurement at 24 ± 2 hours after initial. 	No Visible Damage. Fulfill the electrical specification.	MIL-STD-202 108
Low Temperature Storage	<ol style="list-style-type: none"> Initial measure: Spec: refer Initialspec. Unpowered: 500hours @ T=-30°C. Measurement at 24 ± 2 hours after initial. 	No Visible Damage. Fulfill the electrical specification.	MIL-STD-202 108
Solderability (SMD Bottom Side)	<p>Direct method:</p> <ol style="list-style-type: none"> Temperature: 235 ± 5°C Dipping time: 3 ± 0.5s 	The solder should cover over 95% of the critical area of bottom side.	IEC 60384-21/22 4.10
Soldering Heat Resistance (RSH)	<p>Preheating temperature: 150 ± 10°C. Preheating time: 1~2 min. Solder temperature: 260 ± 5°C. Dipping time: 5 ± 0.5s</p>	No Visible Damage.	IEC 60384-21/22 4.10
Vibration	<p>5g's for 20 min., 12 cycles each of 3 orientations Note: Use 8"X5" PCB .031" thick 7 secure points on, one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10-2000 Hz</p>	No Visible Damage.	MIL-STD-202 Method 204
Mechanical Shock	<p>Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). Duration: 0.5ms Peak value: 1500g's Velocity change: 15.4 ft/s Waveform: Half-sine</p>	No Visible Damage.	MIL-STD-202 Method 213
Humidity Bias	<ol style="list-style-type: none"> Humidity: 85% R.H., Temperature: 85 ± 2 °C. Time: 500 ± 24hours. Measurement at 24 ± 2hrs after testcondition. 	No Visible Damage. Fulfill the electrical specification.	MIL-STD-202 Method 106

2.4GHz 3216 Chip Antenna: RANT3216F245C01



Board Flex (SMD)	1. Mounting method: IR-Reflow. PCB Size (L:100 × W:40 × T:1.6mm) 2. Apply the load in direction of the arrow until bending reaches 2 mm.	No Visible Damage.	AEC-Q200 005
Adhesion	Force of 1.8Kg for 60 seconds. 	No Visible Damage Magnification of 20X or greater may be employed for inspection of the mechanical integrity of the device body terminals and body/terminal junction.	AEC-Q200 006
Physical Dimension	Any applicable method using x10 magnification, micrometers, calipers, gauges, contour projectors, or other measuring equipment, capable of determining the actual specimen dimensions.	In accordance with specification.	JESD22 JB100

Revision History

Revision	Date	Content
1	2019/03/01	New Datasheet
2	2020/02/22	Add 2D radiation characteristic